

# NOT RECOMMENDED FOR NEW DESIGN CONTACT US



DMG1029SV

#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

### **Product Summary**

Device	V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
04	00)/	1.7Ω @ V <sub>GS</sub> = 10V	500mA
Q1	60V	$3\Omega$ @ $V_{GS} = 4.5V$	400mA
Q2	001/	4Ω @ V <sub>GS</sub> = -10V	-360mA
	-60V	6Ω @ V <sub>GS</sub> = -4.5V	-310mA

### Description

This MOSFET has been designed to minimize the on-state resistance  $(R_{DS(on)})$  and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

#### **Applications**

- General Purpose Interfacing Switch
- Power Management Functions
- Analog Switch

### **Features and Benefits**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- · Fast Switching Speed
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

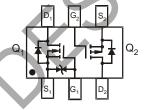
- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe.
   Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.027 grams (approximate)







**Bottom View** 



#### Ordering Information (Note 4 & 5)

Ì	Part Number		Case	Packaging
	DMG1029SV-7		OT563	3000/Tape & Reel

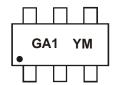
Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

**SOT563** 

- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.
- 5. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product\_grade\_definitions/.

# **Marking Information**



GA1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: W = 2009) M = Month (ex: 9 = September)

#### Date Code Key

Year	200	9	2010		2011	20	)12	2013		2014	2	2015
Code	W		Χ		Υ		Z	А		В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings N-CHANNEL – Q1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage	V <sub>DSS</sub>	60	V		
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Dusin Compart (Nata 7) V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	I <sub>D</sub>	500 400	mA
Continuous Drain Current (Note 7) V <sub>GS</sub> = 10V	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	I <sub>D</sub>	620 480	mA
Pulsed Drain Current (Note 7)	I <sub>DM</sub>	1000	mA		

# Maximum Ratings P-CHANNEL – Q2 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	$V_{DSS}$	-60	V		
Gate-Source Voltage			$V_{GSS}$	±20	V
Continuous Prain Current (Note 7) / 40/	Steady State	$T_A = +25$ °C $T_A = +70$ °C	٥	-360 -280	mA
Continuous Drain Current (Note 7) V <sub>GS</sub> = -10V	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	I <sub>D</sub>	-410 -320	mA
Pulsed Drain Current (Note 7)			I <sub>DM</sub>	-650	mA

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	0.45	W	
Total Fower Dissipation (Note 6)	T <sub>A</sub> = +70°C	Pυ	0.28		
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	J :	281	°C/W	
mermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	210		
Total Power Dissipation (Note 7)	$T_A = +25^{\circ}C$	ם	1	W	
Total Fower Dissipation (Note 7)	$T_A = +70$ °C	$P_D$	0.62		
Thermal Resistance, Junction to Ambient (Note 7)	Steady state	כ	129	°C/W	
Thermal Resistance, Junction to Ambient (Note 1)	t<10s	$R_{\theta JA}$	97		
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to +150	°C	

6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:



# Electrical Characteristics N-CHANNEL - Q1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	60			>	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	$@T_C = +25^{\circ}C$	I <sub>DSS</sub>			10	nA	$V_{DS} = 50V, V_{GS} = 0V$
Gate-Source Leakage		I <sub>GSS</sub>	_	_	±50	nA	$V_{GS} = \pm 5V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage		V <sub>GS(th)</sub>	1.0		2.5	>	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance		D	1	1.3	1.7	Ω	$V_{GS} = 10V, I_D = 500mA$
Static Drain-Source On-Resistance		R <sub>DS(ON)</sub>	1	1.5	3	12	$V_{GS} = 4.5V$ , $I_D = 200mA$
Forward Transfer Admittance		Y <sub>fs</sub>	80			mS	$V_{DS} = 10V, I_D = 200mA$
Diode Forward Voltage		V <sub>SD</sub>	_	_	1.4	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 115mA
DYNAMIC CHARACTERISTICS (Note	9)						
Input Capacitance		C <sub>iss</sub>		30	1	pF	
Output Capacitance		Coss	1	4.2		pF	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance		C <sub>rss</sub>		2.9		pF	1 - 1.0WHZ
Total Gate Charge		Qg		0.3	1	nC	101
Gate-Source Charge		Q <sub>gs</sub>	-	0.2		nC	$V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250mA$
Gate-Drain Charge		$Q_{gd}$	_	0.08		nC	115 = 23011A
Turn-On Delay Time		t <sub>D(on)</sub>	1	3.9	_	ns	
Turn-On Rise Time		t <sub>r</sub>	<u> </u>	3.4	N	ns	V <sub>DD</sub> = 30V, V <sub>GS</sub> = 10V,
Turn-Off Delay Time		t <sub>D(off)</sub>	17.	15.7		ns	$R_G = 25\Omega$ , $I_D = 200mA$
Turn-Off Fall Time		t <sub>f</sub>		9.9		ns	

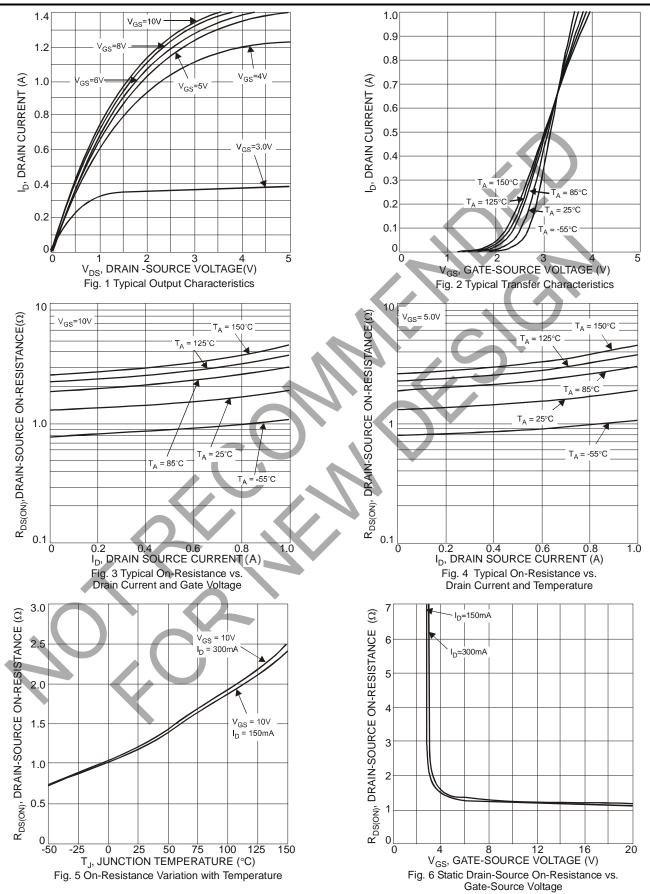
# Electrical Characteristics P-CHANNEL - Q2 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)			7	l	l	
Drain-Source Breakdown Voltage	BVpss	-60	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$
Zero Gate Voltage Drain Current @Tc = -	+25°C I <sub>DSS</sub>		_	-25	nA	V <sub>DS</sub> = -50V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 5V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	-1	_	-3.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance		_	2.7	4	Ω	$V_{GS} = -10V, I_D = -500mA$
Static Drain-Source Off-Resistance	R <sub>DS</sub> (ON)	_	3.2	6	12	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -200mA
Forward Transfer Admittance	Y <sub>fs</sub>	50	_	_	mS	V <sub>DS</sub> = -25V, I <sub>D</sub> = -100mA
Diode Forward Voltage	V <sub>SD</sub>	_	_	-1.4	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -115mA
DYNAMIC CHARACTERISTICS (Note 9)	·					•
Input Capacitance	C <sub>iss</sub>	_	25	_	pF	V 051/ 1/ 01/
Output Capacitance	Coss	_	4.7	_	pF	$V_{DS} = -25V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	2.7	_	pF	1 = 1.0WH12
Total Gate Charge	Qg	_	0.28	_	nC	V 4.5V. V 40V
Gate-Source Charge	Qgs	_	0.14	_	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$ $I_{D} = -500 \text{mA}$
Gate-Drain Charge	$Q_{gd}$	_	0.08	_	nC	- ID = -500IIIA
Turn-On Delay Time	t <sub>D(on)</sub>	_	5.5	_	ns	
Turn-On Rise Time	t <sub>r</sub>	_	7.9	_	ns	$V_{DD} = -30V, V_{GS} = -10V,$
Turn-Off Delay Time	t <sub>D(off)</sub>	_	10.6	_	ns	$R_G = 50\Omega$ , $I_D = -270$ mA
Turn-Off Fall Time	t <sub>f</sub>	_	11.6	_	ns	

8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing. Notes:

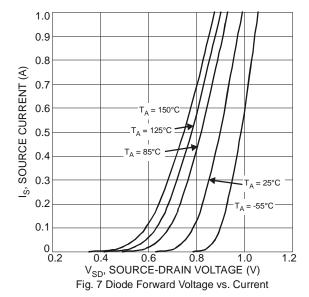


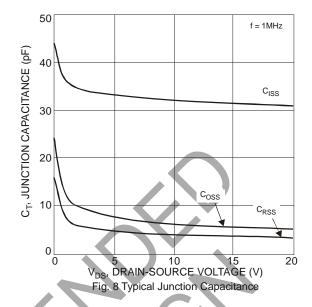
#### N-CHANNEL - Q1





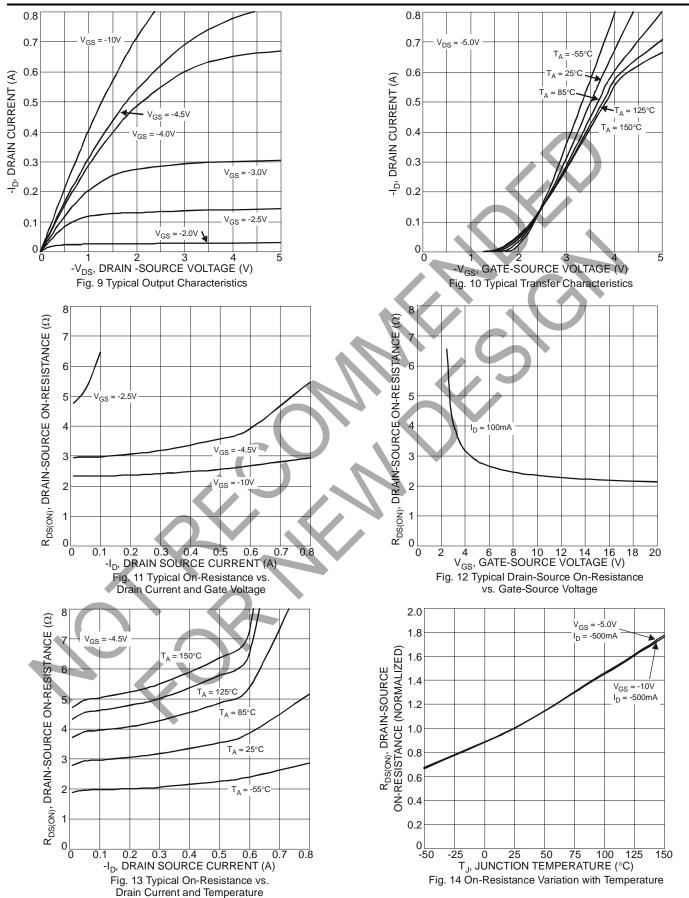




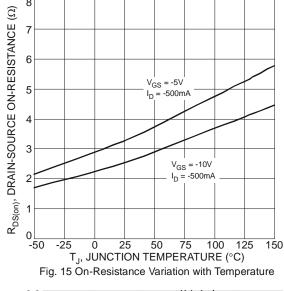


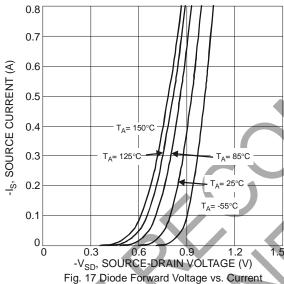


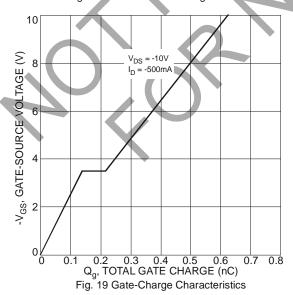
### P-CHANNEL - Q2

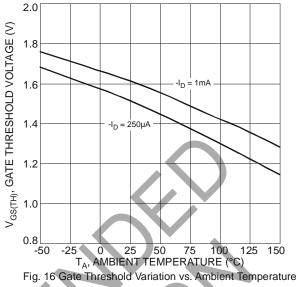


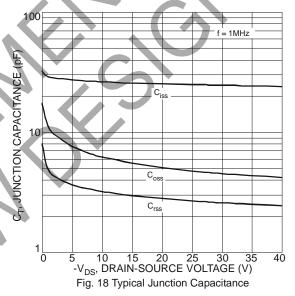








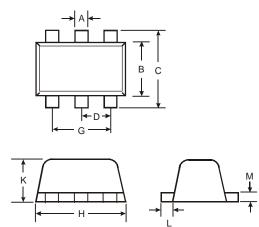






# **Package Outline Dimensions**

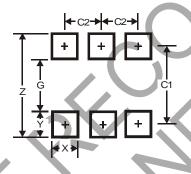
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT563							
Dim	Min	Max	Тур				
Α	0.15	0.30	0.20				
В	1.10	1.25	1.20				
С	1.55	1.70	1.60				
D	-	1	0.50				
G	0.90	1.10	1.00				
Н	1.50	1.70	1.60				
K	0.55	0.60	0.60				
L	0.10	0.30	0.20				
M	0.10	0.18	0.11				
All	Dimens	sions in	mm				

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Υ	0.5
C1	1.7
C2	0.5



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